

ABSTRACT

A resin composition for cleaning a die, including at least a melamine-based resin and an inorganic filler having an average particle diameter of from 4 to 12 μm , a standard deviation of particle diameter of 10 μm or less, an average aspect ratio of particle diameter of from 1 to 1.3, and a standard deviation of aspect ratio of particle diameter of 0.5 or less.